

RoHS

目錄
MAPX

设变内容
MODIFICATION

日期
DATE

NOTES:

1. MATERIAL:

HOUSING: LCP UL94-V0

CONTACT: COPPER ALLOY

SHELL: SUS201

2. ELECTROPLATING SPECIFICATIONS:

NICKEL UNDERLAYER 40U" MIN, CONTACT AREA
GOLD 0.5U" MIN, SOLDER LEG AREA MATTE TIN 80U" MIN.

3. PLATING:

CONTACT: GOLD FLASH PLATED.

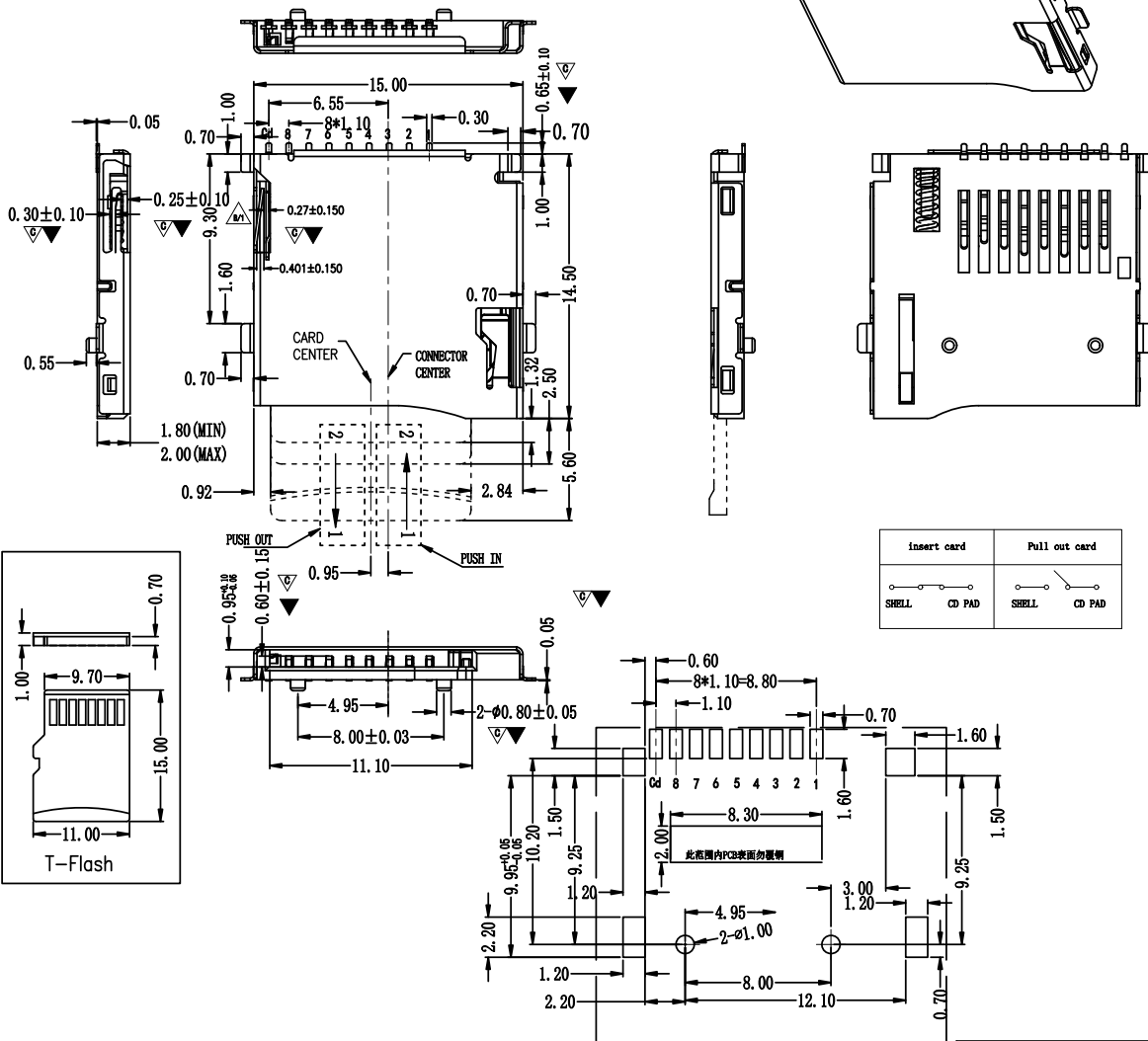
SHELL: NICKEL PLATED.

4. ELECTRICAL CHARACTERISTICS

CONTACT CURRENT RATING : 0.5A MAX

CONTACT RESISTANCE 100 mΩ MAX

INSULATION RESISTANCE 500 MO MIN



RECOMMENDED P.C.B HOLE LAYOUT
COMPONENT SIDE VIEW(TOLERANCE: +/-0.05)

insert card	Pull out card
SHELL CD PAD	SHELL CD PAD

PIN NO.	NAME	YTP	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DAT0	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)
9	CD	CD	CD

产品图

PRODUCT CHART DWG



深圳市精拓金电子有限公司
Shenzhen Jing Tuo Jin Electronics Co., Ltd.

公差一览表 TOLERANCE UNLESS OTHERWISE			
X.	±0.35	X'.	±5'
.X	±0.30	.X'	±2'
.XX	±0.25	.XX'	±1'
.XXX	±0.10	.XXX'	±0.5'

单位 UNITS	MM	制图 DRAWING	Erick	产品料号 PRODUCT PART NO.	920-30002020S20200
比例 SCALE	1:1	审核 CHKD	LSS	产品名称 PRODUCT NO.	T-FLASH 外焊 PUSH
日期 DATE	2021/03/10	核准 APPD	黄国荣	角法 VIEW	
版本 VER	A0				